



# HMC-C013

## 10 WATT POWER AMPLIFIER MODULE, 800 - 2000 MHz

### Features

- P1dB Output Power: 10 Watts
- Gain: 43 dB
- Output IP3: +56 dBm
- Single Positive Supply: +12V
- Thermally Compensated and Protected
- TTL DC Power Enable
- Unconditionally Stable
- Heat Sink/Fan Accessories Available

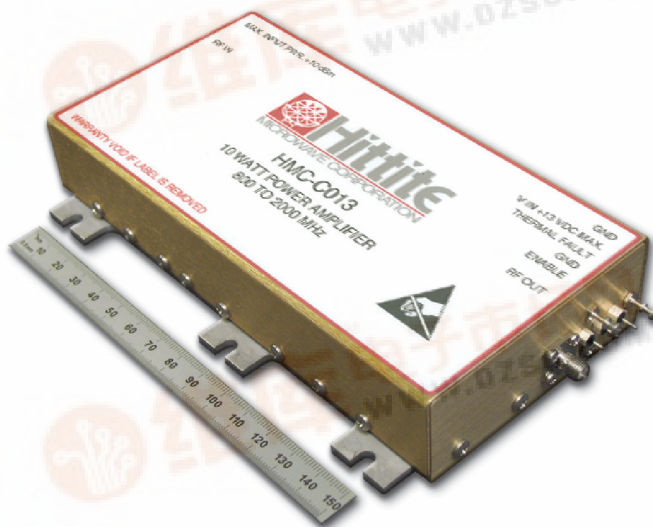
### Typical Applications

The HMC-C013 is ideal for:

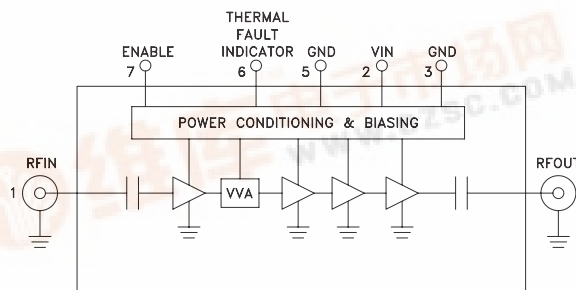
- Cellular/PCS/3G Infrastructure
- Automated Test Equipment (ATE)
- Laboratory Use

### General Description

The HMC-C013 is a 10 Watt Power Amplifier Module suitable for Cellular/3G repeaters, wireless data, laboratory use and ATE applications. This extremely robust PA module is DC blocked, internally regulated and over voltage protected. Thermal protection/fault circuitry automatically turns off DC power if base temperature exceeds +75 °C and restores power at < +55 °C.



### Functional Diagram



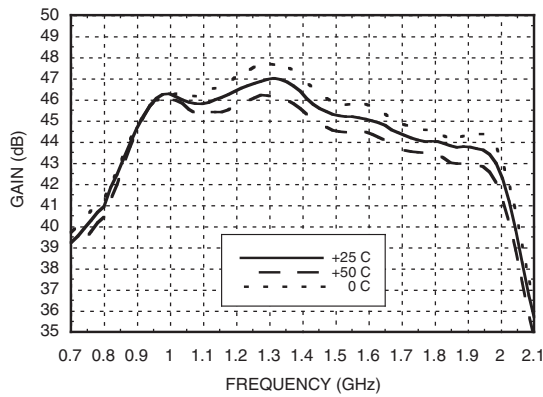
### Electrical Specifications, $T_A = +25^\circ C$ , $V_{IN} = +12V$

Parameter	Min.	Typ.	Max.	Units
Frequency Range		0.8 - 2.0		GHz
Gain	39	43		dB
Input Return Loss	9.5	12		dB
Output Return Loss	7.5	14		dB
Output Power for 1 dB Compression (P1dB)	9	10		W
Saturated Output Power (P <sub>sat</sub> )		42		dBm
Output Third Order Intercept (IP3) (Two-tone Input Power = -28 dBm each tone)		56		dBm
Channel Output Power for -60 dBc ACPR (CDMA-2000, 1.98 MHz offset)		38		dBm
Channel Output Power for -50 dBc ACPR (CDMA-2000, 885 kHz offset)		35		dBm
Second Harmonic at Output P1dB		-20		dBc
Third Harmonic at Output P1dB		-30		dBc
Spurious at Output P1dB		-65		dBc
Supply Current		6.5	7.0	A

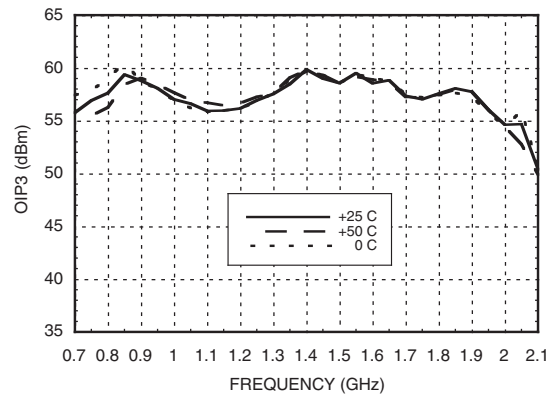


**10 WATT POWER AMPLIFIER  
MODULE, 800 - 2000 MHz**

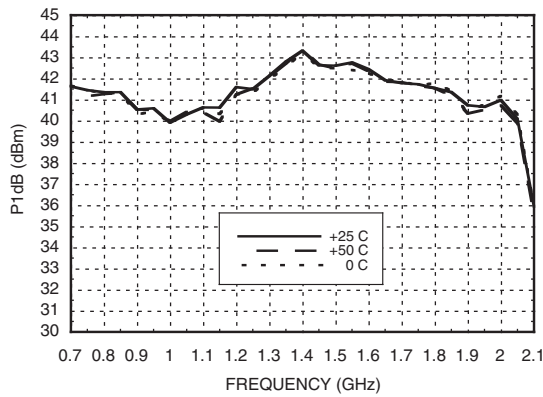
**Gain vs. Temperature**



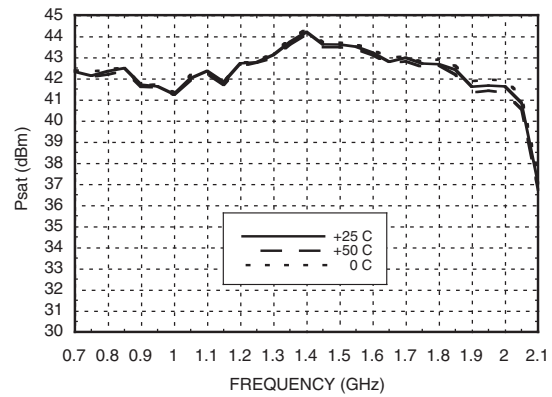
**Output IP3 vs. Temperature**



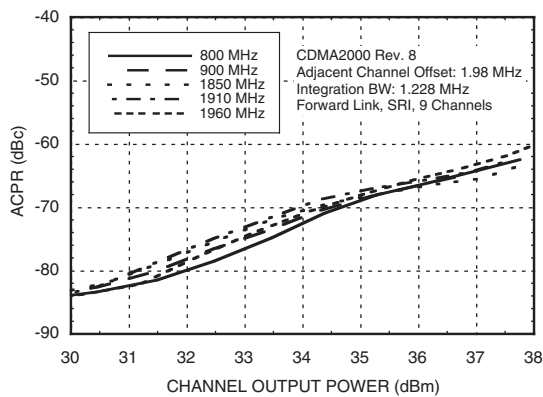
**P1dB vs. Temperature**



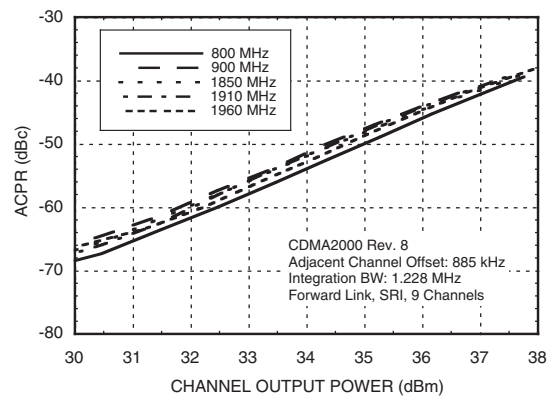
**Psat vs. Temperature**



**ACPR, CDMA-2000, 1.98 MHz Offset**

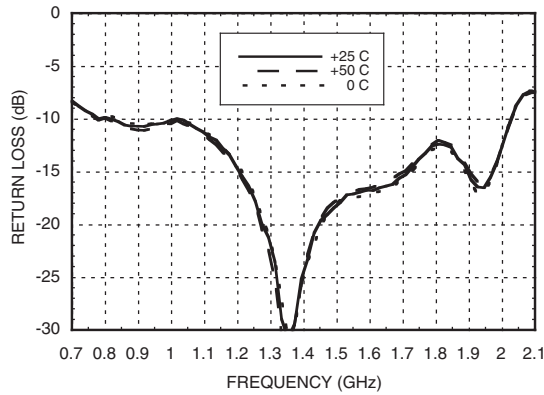


**ACPR, CDMA-2000, 885 kHz Offset**

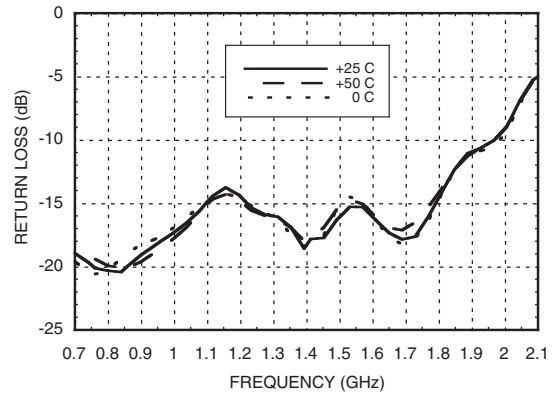


## 10 WATT POWER AMPLIFIER MODULE, 800 - 2000 MHz

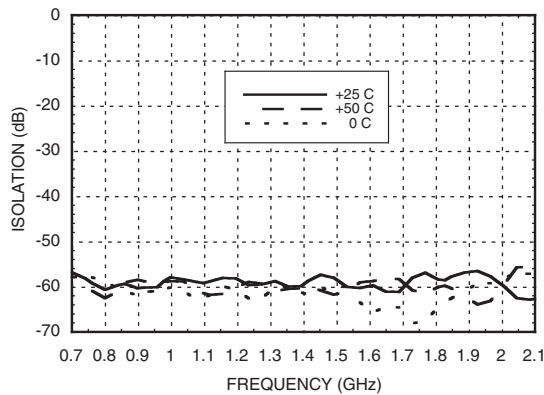
**Input Return Loss vs. Temperature**



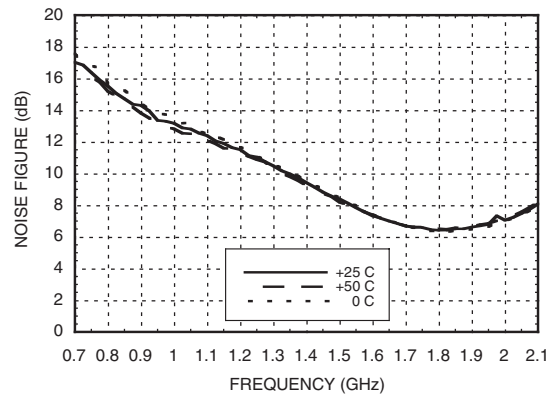
**Output Return Loss vs. Temperature**



**Reverse Isolation vs. Temperature**



**Noise Figure vs. Temperature**



**Absolute Maximum Ratings**

Supply Voltage (VIN)	+13 Vdc
RF Input Power (RFIN)	+10 dBm
Storage Temperature	-40 to +85 °C
Operating Temperature	0 to +50 °C
Thermal Fault Indicator Max P <sub>diss</sub> (derate 1.8 mW/°C above 50 °C)	180 mW
Enable	-0.5 to +6.0 Vdc

**Thermal Fault Indicator  
Characteristics**

Parameter	Min.	Typ.	Max.	Units
I <sub>OUT</sub> (V <sub>OUT</sub> > 2V)		350		mA
R <sub>ON</sub> (I <sub>OUT</sub> = 50 mA)			7.5	Ohms
R <sub>OFF</sub> (V <sub>OUT</sub> = 30 V)		1		MOhm



ELECTROSTATIC SENSITIVE DEVICE  
OBSERVE HANDLING PRECAUTIONS

**Enable Input Characteristics**

Parameter	Min.	Typ.	Max.	Units
V <sub>IH</sub>	3.5			V
V <sub>IL</sub>			1.6	V
I <sub>IL</sub> @ VIN = 0V		-0.5		mA
I <sub>IH</sub> @ 5V		< ± 50		µA

### Recommended Biasing Procedure

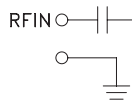
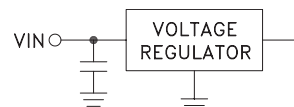

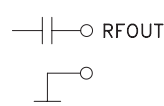

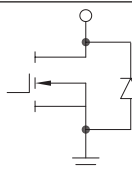
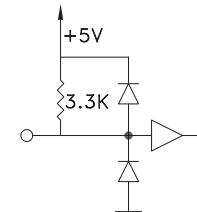
#### TURN-ON

1. Connect RF input and output
2. Apply Supply Voltage VIN (+12 Vdc)
3. Set Enable low
4. Apply RF input signal

#### TURN-OFF

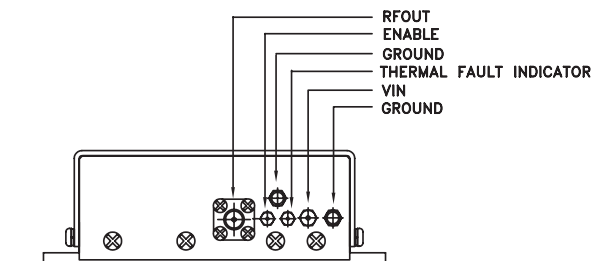
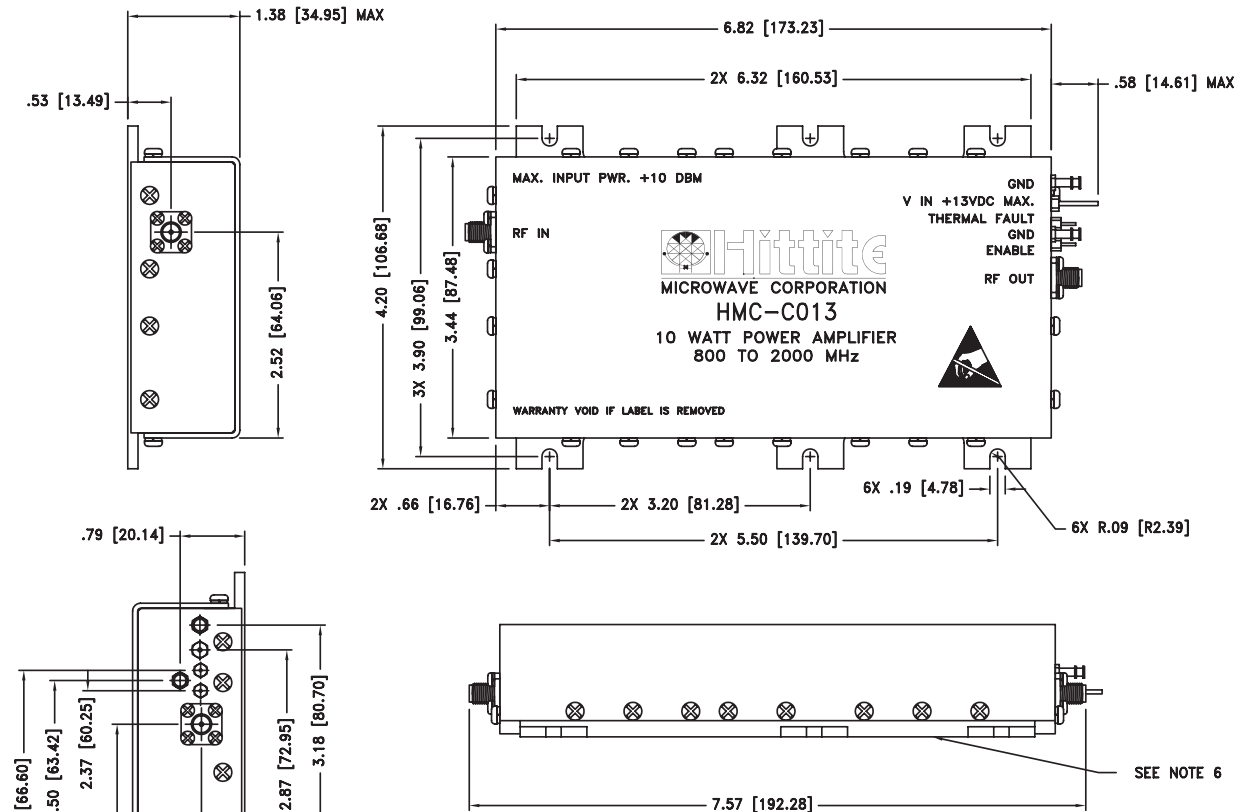
1. Remove RF input signal
2. Remove Supply Voltage VIN

### Pin Descriptions

Pin Number	Function	Description	Interface Schematic
1	RFIN & RF Ground	RF input connector, SMA female. This pin is AC coupled and matched to 50 Ohms from 800 - 2000 MHz.	
2	VIN	Power supply voltage for the amplifier.	
3	GND	Power supply ground.	
4	RFOUT & RF Ground	RF output connector, SMA female. This pin is AC coupled and matched to 50 Ohms from 800 - 2000 MHz.	
5	GND	Ground for thermal fault indicator and enable circuit.	
6	Thermal Fault Indicator	Open drain output. High impedance for base plate temperatures less than 55 °C. Low impedance for base plate temperatures exceeding 75 °C.	
7	Enable	TTL compatible supply voltage (VIN) shutdown. If enable feature is not required, short this pin to DC ground.  TTL "High" Disable TTL "Low" Enable	

## 10 WATT POWER AMPLIFIER MODULE, 800 - 2000 MHz

### Outline Drawing

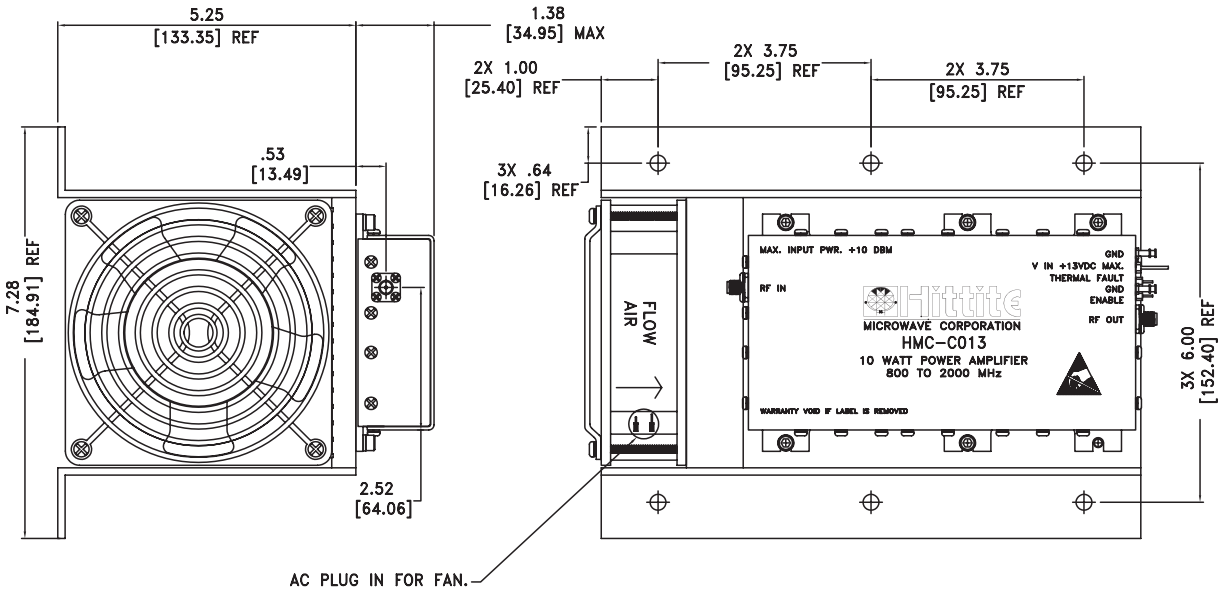


#### NOTES:

1. MATERIAL: ALUMINUM 6061-T6
2. FINISH
  - a. COVER & END PLATES, CHEMICAL FILM PER MIL-C-5541, CLASS 3
  - b. BASE, TIN
3. RF CONNECTORS, SMA STYLE
4. DIMENSIONS ARE INCHES (MM)
5. TOLERANCES .X±.1 (2.54mm)  
.XX±.02 (0.50mm)
6. DRAWING TO CHANGE AS REQUIRED.
7. BASE MUST BE GROUNDED AND MOUNTED TO HEAT SINK CAPABLE OF DISSIPATING 100W (65 °C)

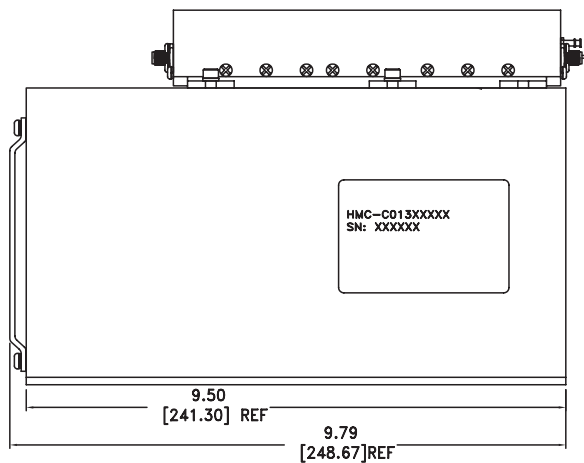
## 10 WATT POWER AMPLIFIER MODULE, 800 - 2000 MHz

### HMC-C013 Heatsink/Fan Outline Drawing



NOTES:

1. MATERIAL: ALUMINUM 6061-T6
2. FINISH: COVER & END PLATES, CHEMICAL FILM PER MIL-C-5541, CLASS 3
3. RF CONNECTORS, SMA STYLE
4. DIMENSIONS ARE INCHES (MM)
5. TOLERANCES .X±.1 (2.54mm)  
.XX±.02 (0.50mm)



### HMC-C008 Ordering Information

Part Number	Description
HMC-C013	10 Watt Power Amplifier Module, 800 - 2000 MHz
HMC-C013HV115	10 Watt Power Amplifier Module with heat sink, 115 Vac fan and power cord.
HMC-C013HV230	10 Watt Power Amplifier Module with heat sink, 230 Vac fan and power cord.

